



## Description

### JMP N-channel Enhancement Mode Power MOSFET

#### Features

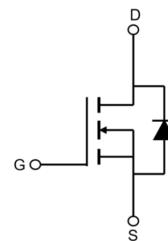
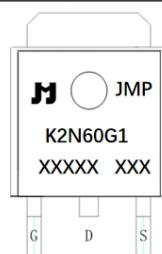
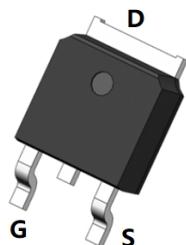
- 600V, 2A
- $R_{DS(ON)} < 4.7\Omega$  @  $V_{GS} = 10V$
- Fast Switching
- Improved dv/dt Capability

#### Application

- Load Switch
- PWM Application
- Power management



100% UIS TESTED!  
100%  $\Delta V_{ds}$  TESTED!



TO-252-4R (DPAK) top view

Marking and pin Assignment

Schematic Diagram

## Package Marking and Ordering Information

Device Marking	Device	OUTLINE	Device Package	Reel Size	Reel (PCS)	Per Carton (PCS)
JMPK2N60G1	JMPK2N60G1	TAPING	TO-252-4R	13inch	2500	25000

## Absolute Maximum Ratings ( $T_c=25^\circ C$ unless otherwise specified)

Symbol	Parameter		Max.	Units
$V_{DSS}$	Drain-Source Voltage		600	V
$V_{GSS}$	Gate-Source Voltage		$\pm 30$	V
$I_D$	Continuous Drain Current	$T_c = 25^\circ C$	2	A
		$T_c = 100^\circ C$	1.3	A
$I_{DM}$	Pulsed Drain Current <sup>note1</sup>		8	A
$E_{AS}$	Single Pulsed Avalanche Energy <sup>note2</sup>		39.2	mJ
$P_D$	Power Dissipation	$T_c = 25^\circ C$	54	W
$R_{eJC}$	Thermal Resistance, Junction to Case		2.3	$^\circ C/W$
$R_{eJA}$	Thermal Resistance, Junction to Ambient		62.5	$^\circ C/W$
$T_J, T_{STG}$	Operating and Storage Temperature Range		-55 to +150	$^\circ C$

**Electrical Characteristics** ( $T_J=25^\circ\text{C}$  unless otherwise specified)

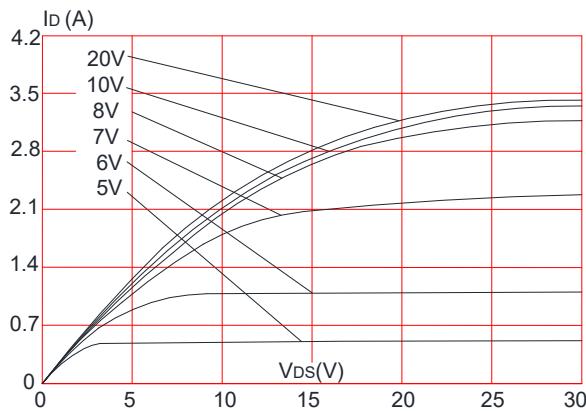
Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Units
<b>Off Characteristic</b>						
$V_{(\text{BR})\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{GS}=0\text{V}$ , $I_D=250\mu\text{A}$	600	-	-	V
$I_{\text{DSS}}$	Zero Gate Voltage Drain Current	$V_{DS}=600\text{V}$ , $V_{GS}=0\text{V}$ , $T_J=25^\circ\text{C}$	-	-	1	$\mu\text{A}$
$I_{GSS}$	Gate to Body Leakage Current	$V_{DS}=0\text{V}$ , $V_{GS}= \pm 30\text{V}$	-	-	$\pm 100$	nA
<b>On Characteristics</b>						
$V_{GS(\text{th})}$	Gate Threshold Voltage	$V_{DS}=V_{GS}$ , $I_D=250\mu\text{A}$	2	-	4	V
$R_{DS(\text{on})}$	Static Drain-Source on-Resistance note3	$V_{GS} = 10\text{V}$ , $I_D = 1\text{A}$	-	3.9	4.7	$\Omega$
<b>Dynamic Characteristics</b>						
$C_{iss}$	Input Capacitance	$V_{DS}=25\text{V}$ , $V_{GS}=0\text{V}$ , $f=1.0\text{MHz}$	-	293	-	pF
$C_{oss}$	Output Capacitance		-	35	-	pF
$C_{rss}$	Reverse Transfer Capacitance		-	7	-	pF
$Q_g$	Total Gate Charge	$V_{DD}=480\text{V}$ , $I_D=2\text{A}$ , $V_{GS}=10\text{V}$	-	10	-	nC
$Q_{gs}$	Gate-Source Charge		-	1.5	-	nC
$Q_{gd}$	Gate-Drain("Miller") Charge		-	5	-	nC
<b>Switching Characteristics</b>						
$t_{d(on)}$	Turn-on Delay Time	$V_{DD}=300\text{V}$ , $I_D=2\text{A}$ , $R_G=25\Omega$	-	33.6	-	ns
$t_r$	Turn-on Rise Time		-	7.2	-	ns
$t_{d(off)}$	Turn-off Delay Time		-	64	-	ns
$t_f$	Turn-off Fall Time		-	31.2	-	ns
<b>Drain-Source Diode Characteristics and Maximum Ratings</b>						
$I_s$	Maximum Continuous Drain to Source Diode Forward Current	-	-	2	A	
$I_{SM}$	Maximum Pulsed Drain to Source Diode Forward Current	-	-	8	A	
$V_{SD}$	Drain to Source Diode Forward Voltage	$V_{GS}=0\text{V}$ , $I_{SD}=2\text{A}$	-	-	1.4	V
$t_{rr}$	Reverse Recovery Time	$V_{GS}=0\text{V}$ , $I_s=2\text{A}$ , $dI/dt=100\text{A}/\mu\text{s}$	-	180	-	ns
$Q_{rr}$	Reverse Recovery Charge		-	0.6	-	$\mu\text{C}$

Notes:1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature

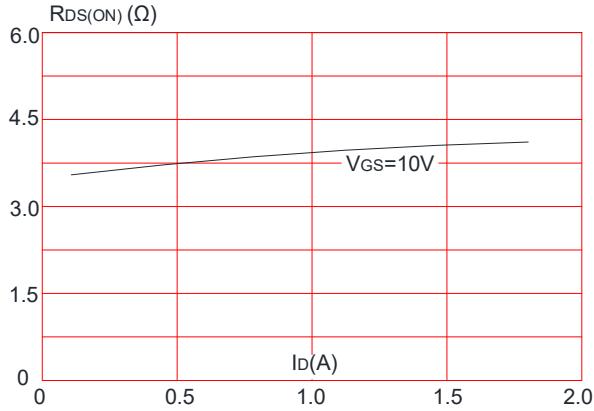
2. EAS condition:  $T_J = 25^\circ\text{C}$ ,  $V_{DD} = 120\text{V}$ ,  $V_G = 10\text{V}$ ,  $L = 10\text{mH}$ ,  $I_{AS} = 2.8\text{A}$ 3. Pulse Test: Pulse Width $\leq 300\mu\text{s}$ , Duty Cycle $\leq 1\%$

## Typical Performance Characteristics

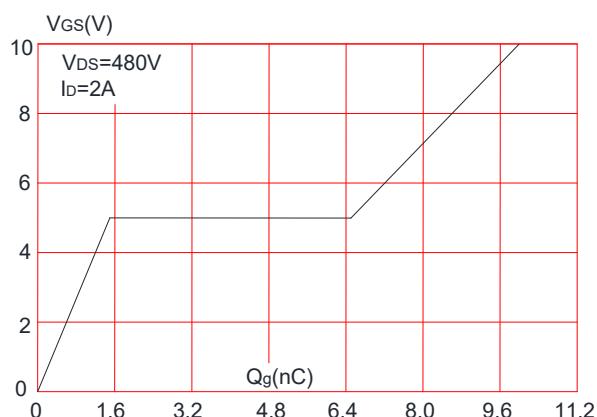
**Figure 1:** Output Characteristics



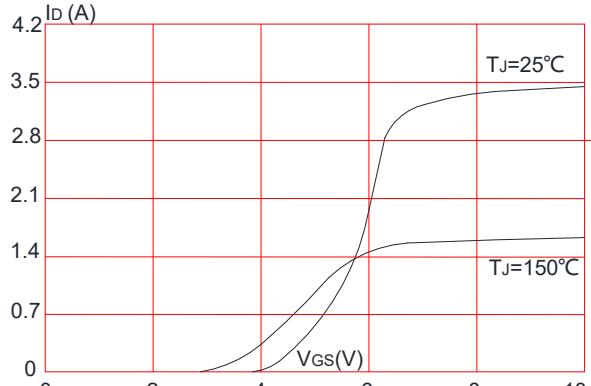
**Figure 3:** On-resistance vs. Drain Current



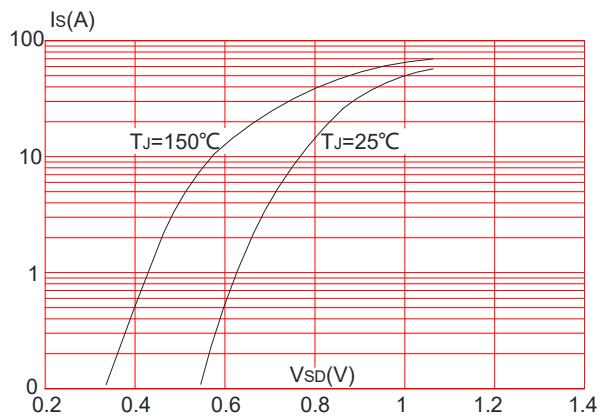
**Figure 5: Gate Charge Characteristics**



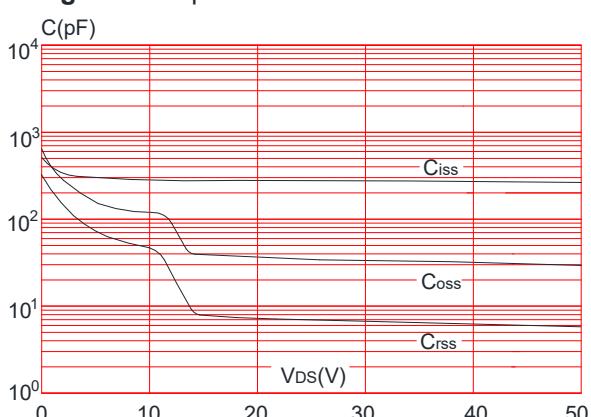
**Figure 2:** Typical Transfer Characteristics



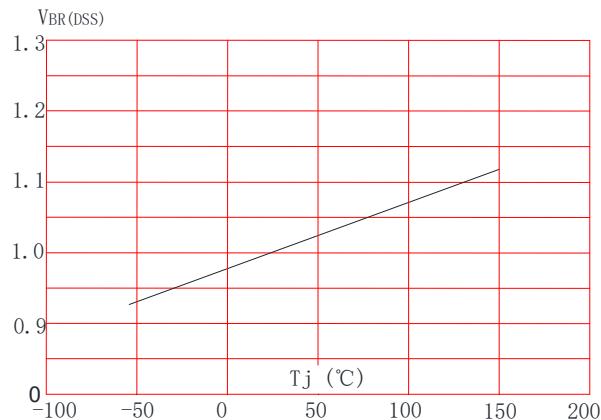
**Figure 4:** Body Diode Characteristics



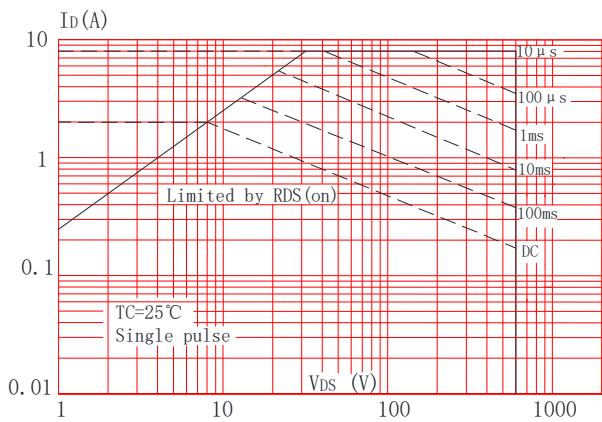
**Figure 6: Capacitance Characteristics**



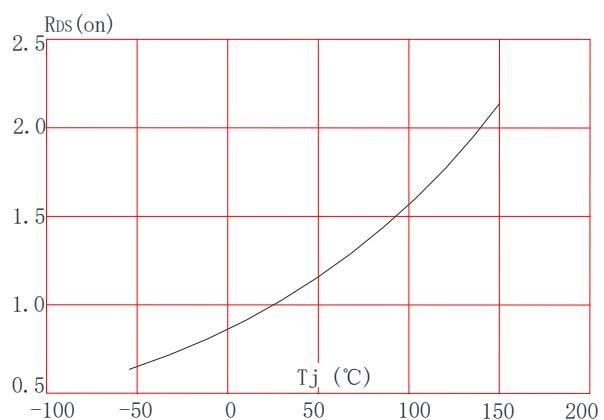
**Figure 7:** Normalized Breakdown Voltage vs. Junction Temperature



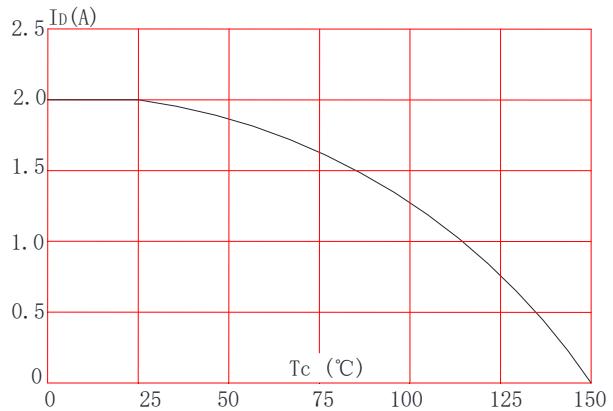
**Figure 9:** Maximum Safe Operating Area



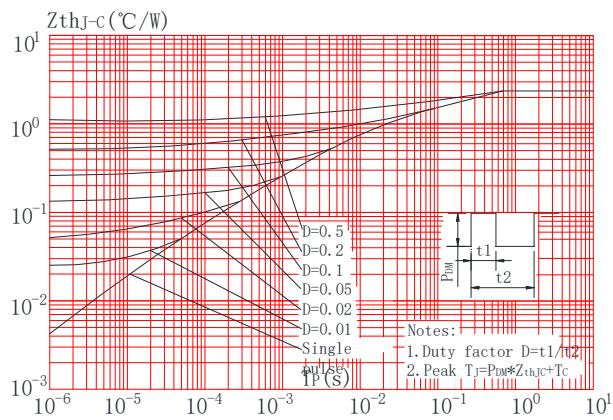
**Figure 8:** Normalized on Resistance vs. Junction Temperature



**Figure 10:** Maximum Continuous Drain Current vs. Case Temperature



**Figure 11:** Maximum Effective Transient Thermal Impedance, Junction-to-Case



## Test Circuit

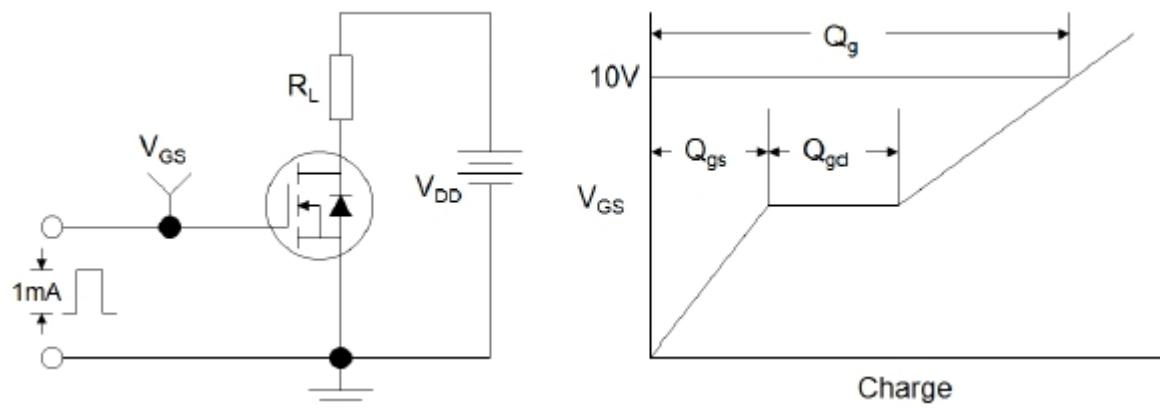


Figure1:Gate Charge Test Circuit & Waveform

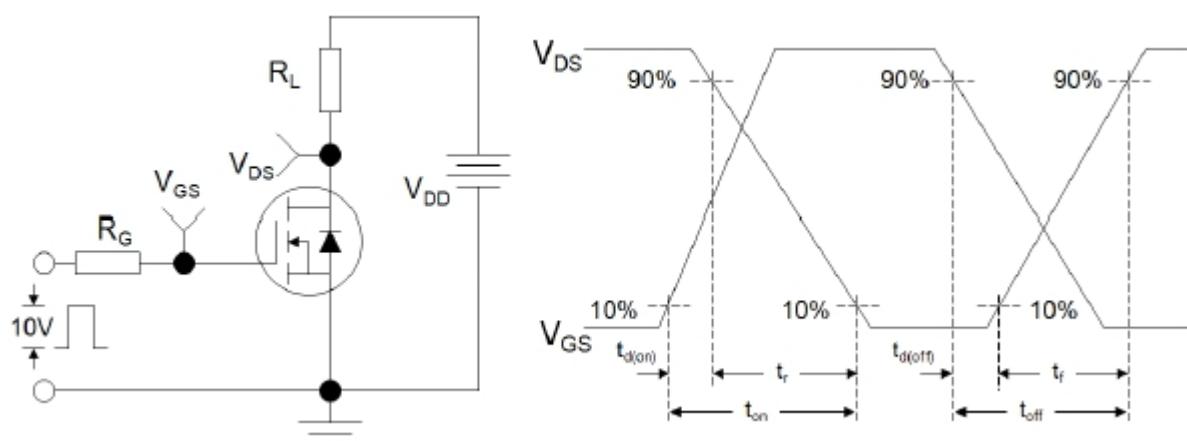


Figure 2: Resistive Switching Test Circuit & Waveforms

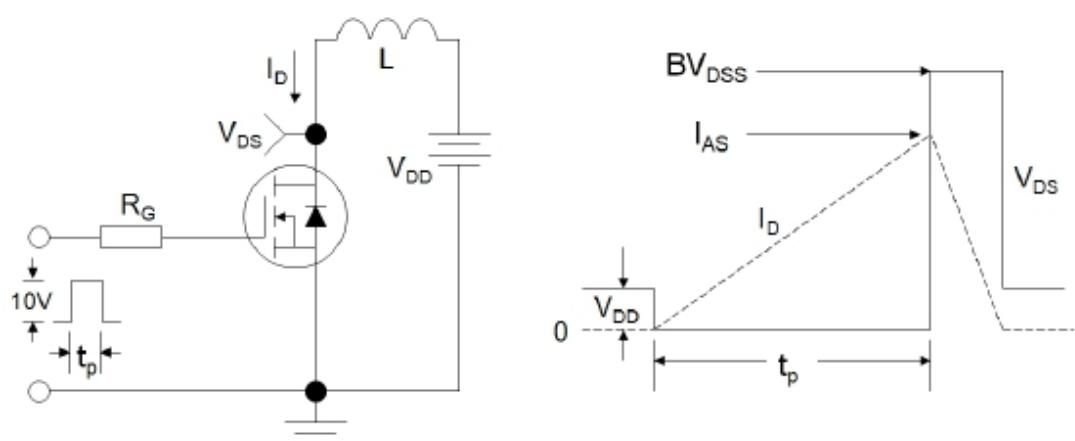
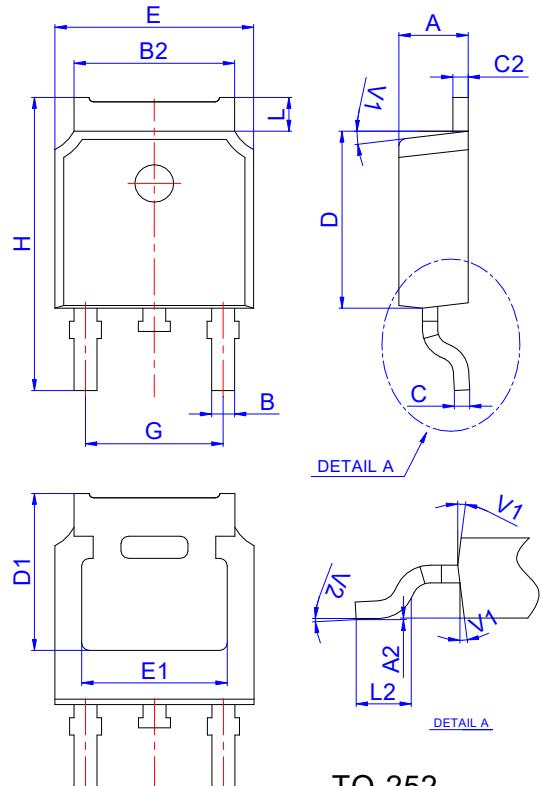


Figure 3:Unclamped Inductive Switching Test Circuit & Waveforms



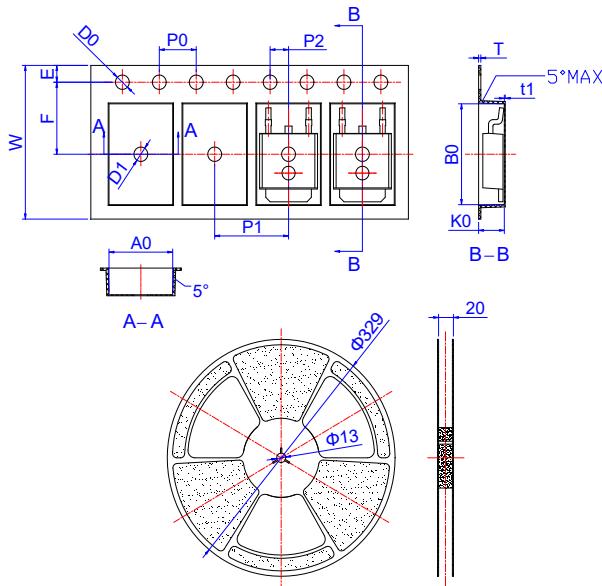
## Package Mechanical Data-TO-252-4R



TO-252

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	2.10		2.50	0.083		0.098
A2	0		0.10	0		0.004
B	0.66		0.86	0.026		0.034
B2	5.18		5.48	0.202		0.216
C	0.40		0.60	0.016		0.024
C2	0.44		0.58	0.017		0.023
D	5.90		6.30	0.232		0.248
D1	5.30REF			0.209REF		
E	6.40		6.80	0.252		0.268
E1	4.63			0.182		
G	4.47		4.67	0.176		0.184
H	9.50		10.70	0.374		0.421
L	1.09		1.21	0.043		0.048
L2	1.35		1.65	0.053		0.065
V1		7°			7°	
V2	0°		6°	0°		6°

## Reel Specification-TO-252-4R



Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
W	15.90	16.00	16.10	0.626	0.630	0.634
E	1.65	1.75	1.85	0.065	0.069	0.073
F	7.40	7.50	7.60	0.291	0.295	0.299
D0	1.40	1.50	1.60	0.055	0.059	0.063
D1	1.40	1.50	1.60	0.055	0.059	0.063
P0	3.90	4.00	4.10	0.154	0.157	0.161
P1	7.90	8.00	8.10	0.311	0.315	0.319
P2	1.90	2.00	2.10	0.075	0.079	0.083
A0	6.85	6.90	7.00	0.270	0.271	0.276
B0	10.45	10.50	10.60	0.411	0.413	0.417
K0	2.68	2.78	2.88	0.105	0.109	0.113
T	0.24		0.27	0.009		0.011
t1	0.10			0.004		
10P0	39.80	40.00	40.20	1.567	1.575	1.583



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